

TFT DISPLAY SPECIFICATION



WINSTAR Display Co.,Ltd.
華凌光電股份有限公司



Winstar Display Co., LTD

華凌光電股份有限公司



WEB: <https://www.winstar.com.tw> E-mail: sales@winstar.com.tw

SPECIFICATION

CUSTOMER : _____

MODULE NO.: **WF50FTWAGDNN0#**

APPROVED BY: (FOR CUSTOMER USE ONLY)	PCB VERSION:	DATA:
	☐ TFT Display Inspection Specification: https://www.winstar.com.tw/technology/download.html ☐ Precaution in use of TFT module: https://www.winstar.com.tw/technology/download/declaration.html	

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
			葉虹蘭
ISSUED DATE:	2025/01/13		

RECORDS OF REVISION

DOC. FIRST ISSUE

VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2019/11/25		First issue
A	2021/05/20		Modify IC information.
B	2021/07/05		Correct Aspect Ratio
C	2023/04/27		Modify Power ON/OFF Sequence
D	2023/10/02		Modify Contour drawing
E	2024/03/27		Modify Static electricity test
F	2025/01/13		Modify Reliability

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4.Absolute Maximum Ratings

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8.Optical Characteristics

9.Interface

10.Reliability

11.Contour Drawing

12.Other

1.Module Classification Information

W F 50 F T W A G D N N 0 #
 ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪ ⑫ ⑬

①	Brand : WINSTAR DISPLAY CORPORATION																																																																							
②	Display Type : F→TFT Type, J→Custom TFT																																																																							
③	Display Size : 5.0” TFT																																																																							
④	Model serials no.																																																																							
⑤	Backlight Type :	F→CCFL, White S→LED, High Light White						T→LED, White Z→Nichia LED, White																																																																
⑥	LCD Polarize Type/ Temperature range/ Gray Scale Inversion Direction	A→Transmissive, N.T, IPS TFT C→Transmissive, N. T, 6:00 ; F→Transmissive, N.T,12:00 ; I→Transmissive, W. T, 6:00 K→Transflective, W.T,12:00 L→Transmissive, W.T,12:00 N→Transmissive, Super W.T, 6:00						Q→Transmissive, Super W.T, 12:00 R→Transmissive, Super W.T, O-TFT V→Transmissive, Super W.T, VA TFT W→Transmissive, Super W.T, IPS TFT X→Transmissive, W.T, VA TFT Y→Transmissive, W.T, IPS TFT Z→Transmissive, W.T, O-TFT																																																																
⑦	A : TFT LCD B : TFT+SCREW HOLES+CONTROL BOARD C : TFT+ SCREW HOLES +A/D BOARD D : TFT+ SCREW HOLES +A/D BOARD+CONTROL BOARD E : TFT+ SCREW HOLES +POWER BOARD						F : TFT+CONTROL BOARD G : TFT+ SCREW HOLES H : TFT+D/V BOARD I : TFT+ SCREW HOLES +D/V BOARD J : TFT+POWER BD																																																																	
⑧	Resolution: <table><tr><td>A</td><td>128160</td><td>B</td><td>320234</td><td>C</td><td>320240</td><td>D</td><td>480234</td><td>E</td><td>480272</td><td>F</td><td>640480</td></tr><tr><td>G</td><td>800480</td><td>H</td><td>1024600</td><td>I</td><td>320480</td><td>J</td><td>240320</td><td>K</td><td>800600</td><td>L</td><td>240400</td></tr><tr><td>M</td><td>1024768</td><td>N</td><td>128128</td><td>P</td><td>1280800</td><td>Q</td><td>480800</td><td>R</td><td>640320</td><td>S</td><td>480128</td></tr><tr><td>T</td><td>800320</td><td>U</td><td>8001280</td><td>V</td><td>176220</td><td>W</td><td>1280398</td><td>X</td><td>1024250</td><td>Y</td><td>1920720</td></tr><tr><td>Z</td><td>800200</td><td>2</td><td>1024324</td><td>3</td><td>7201280</td><td>4</td><td>19201200</td><td>5</td><td>1366768</td><td>6</td><td>1280320</td></tr></table>												A	128160	B	320234	C	320240	D	480234	E	480272	F	640480	G	800480	H	1024600	I	320480	J	240320	K	800600	L	240400	M	1024768	N	128128	P	1280800	Q	480800	R	640320	S	480128	T	800320	U	8001280	V	176220	W	1280398	X	1024250	Y	1920720	Z	800200	2	1024324	3	7201280	4	19201200	5	1366768	6	1280320
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⑨	D: Digital L : LVDS M:MIPI																																																																							
⑩	Interface: <table><tr><td>N</td><td>Without control board</td><td>A</td><td>8Bit</td><td>B</td><td>16Bit</td><td>H</td><td>HDMI</td></tr><tr><td>I</td><td>I2C Interface</td><td>R</td><td>RS232</td><td>S</td><td>SPI Interface</td><td>U</td><td>USB</td></tr></table>												N	Without control board	A	8Bit	B	16Bit	H	HDMI	I	I2C Interface	R	RS232	S	SPI Interface	U	USB																																												
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⑪	TS: <table><tr><td>N</td><td>Without TS</td><td>T</td><td>Resistive touch panel</td><td>C</td><td>Capacitive touch panel (G-F-F)</td></tr><tr><td>G</td><td>Capacitive touch panel (G-G)</td><td>C1</td><td>Capacitive touch panel (G-F-F)+OCA</td></tr><tr><td>C2</td><td>Capacitive touch panel (G-F-F)+OCR</td><td>G1</td><td>Capacitive touch panel (G-G)+OCA</td></tr><tr><td>G2</td><td>Capacitive touch panel (G-G)+OCR</td><td>B</td><td>CTP+GG+USB</td></tr></table>												N	Without TS	T	Resistive touch panel	C	Capacitive touch panel (G-F-F)	G	Capacitive touch panel (G-G)	C1	Capacitive touch panel (G-F-F)+OCA	C2	Capacitive touch panel (G-F-F)+OCR	G1	Capacitive touch panel (G-G)+OCA	G2	Capacitive touch panel (G-G)+OCR	B	CTP+GG+USB																																										
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⑫	Version: X:Raspberry pi																																																																							
⑬	Special Code	#:Fit in with ROHS directive regulations																																																																						

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WINSTAR DISPLAY Co., Ltd.

2.Summary

TFT 5.0" is a color active matrix thin film transistor (TFT) liquid crystal display (LCD) that uses amorphous silicon TFT as a switching device. This TFT LCD has a 5.0 inch diagonally measured active display area with 800x480 (800 horizontal by 480 vertical pixel) resolution.

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3.General Specifications

Item	Dimension	Unit
Size	5.0	inch
Dot Matrix	800× 3(RGB) × 480	dots
Module dimension	120.7(W) ×75.8(H) ×2.8	mm
Active area	108(W) ×64.8 (H)	mm
Pixel pitch	0.135(W) ×0.135(H)	mm
LCD type	TFT, Normally Black, Transmissive	
View Direction	80/80/80/80	
Aspect Ratio	5:3	
Driver IC	ST7262 or equivalent	
Interface	24 bit R.G.B.	
Backlight Type	LED ,Normally White	
With /Without TP	Without TP	
Surface	Anti-Glare	

*Color tone slight changed by temperature and driving voltage.

4. Absolute Maximum Ratings

Item	Symbol	Min	Typ	Max	Unit
Operating Temperature	TOP	-30	—	+80	°C
Storage Temperature	TST	-30	—	+80	°C

Note: Device is subject to be damaged permanently if stresses beyond those absolute maximum ratings listed above

1. Temp. $\leq 60^{\circ}\text{C}$, 90% RH MAX. Temp. $> 60^{\circ}\text{C}$, Absolute humidity shall be less than 90% RH at 60°C

5. Electrical Characteristics

5.1. Typical Operation Conditions

Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Power voltage	VDD	3.1	3.3	3.6	V	
Current for Driver(Black)	IDD	-	65	97.5	mA	VDD=3.3V
Input logic high voltage	VIH	0.7 VDD	-	VDD	V	Note 1
Input logic low voltage	VIL	0	-	0.3 VDD		

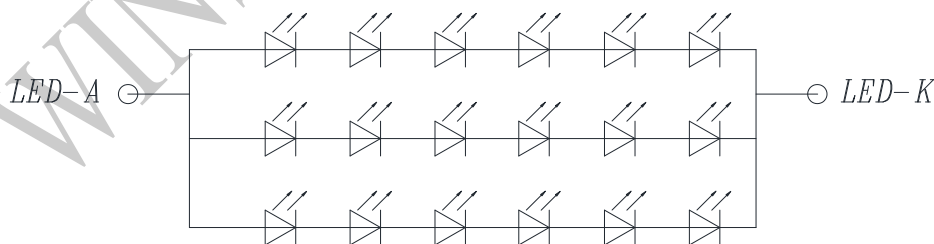
Note1: CLK,DE,R0~R7, G0~7, B0~7.

5.2. Backlight Driving Conditions

Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Voltage for LED backlight	VL	16.8	19.2	20.4	V	Note 1
Current for LED backlight	IL	--	60	--	mA	
LED life time	-	--	50,000	-	Hr	Note 2

Note 1: The LED Supply Voltage is defined by the number of LED at Ta=25°C and IL=20mA/pcs.

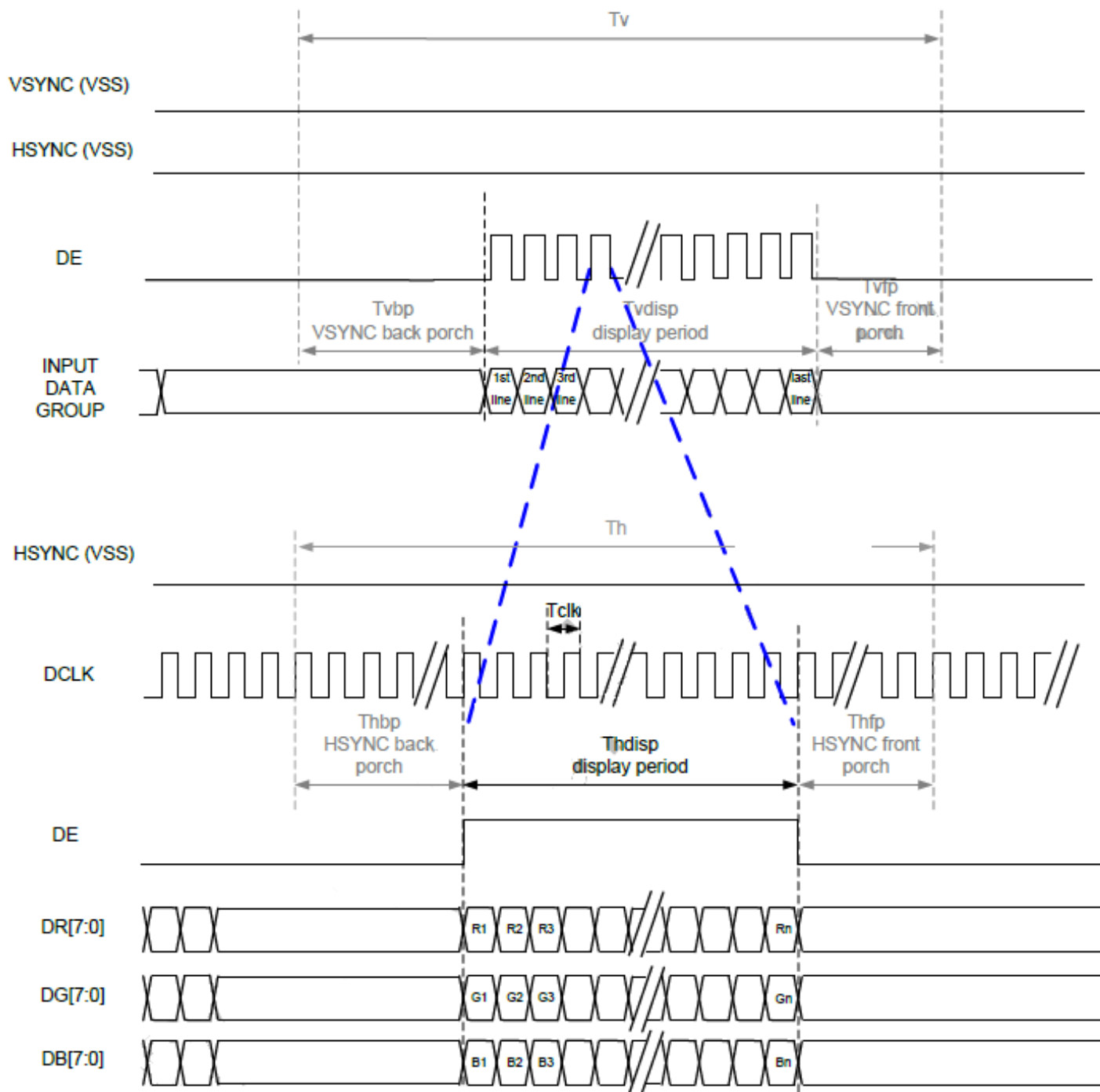
Note 2: The "LED life time" is defined as the module brightness decrease to 50% Original brightness at Ta=25°C and IL=20mA/pcs. The LED lifetime could be decreased if operating IL is larger than 25mA/pcs.



CIRCUIT DIAGRAM(LED 3*6=18 DIES)

6. Communication Interface

6.1. DE Mode



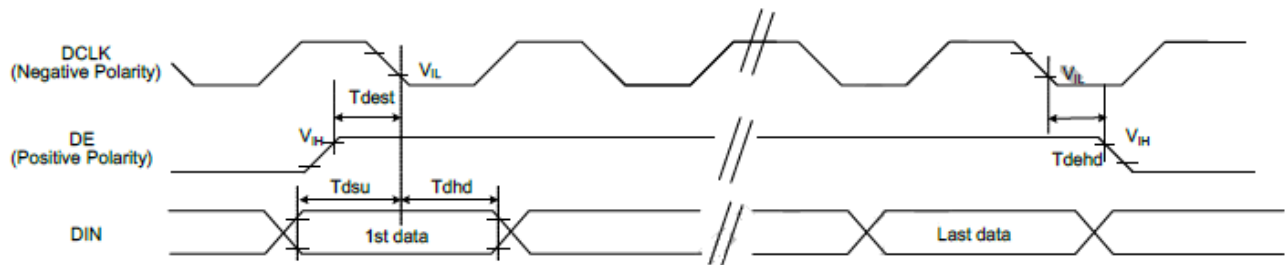
6.2. Parallel 24-bit RGB Input Timing Table

Parallel 24-bit RGB Input Timing (VDD=VDDI= 3.3V, GND= 0V, TA=25°C)

Parallel 24-bit RGB Interface Timing Table						
Item	Symbol	Min.	Typ.	Max.	Unit	Remark
DCLK Frequency	Fclk	23	25	27	MHz	
HSYNC	Period Time	Th	808	816	896	DCLK
	Display Period	Thdisp	800		DCLK	
	Back Porch	Thbp	4	8	48	DCLK
	Front Porch	Thfp	4	8	48	DCLK
	Pulse Width	Thw	2	4	8	DCLK
VSYNC	Period Time	Tv	492	496	504	HSYNC
	Display Period	Tvdisp	480		HSYNC	
	Back Porch	Tvbp	6	8	12	HSYNC
	Front Porch	Tvfp	6	8	12	HSYNC
	Pulse Width	Tvw	2	4	8	HSYNC

Note: 1. The minimum blanking time depends on the GIP timing of the panel specification
2. To ensure the compatibility of different panels, it is recommended to use the typical setting.
3. It is necessary to keep Tvbp =12 and Thbp =43 in sync mode. DE mode is unnecessary to keep it.

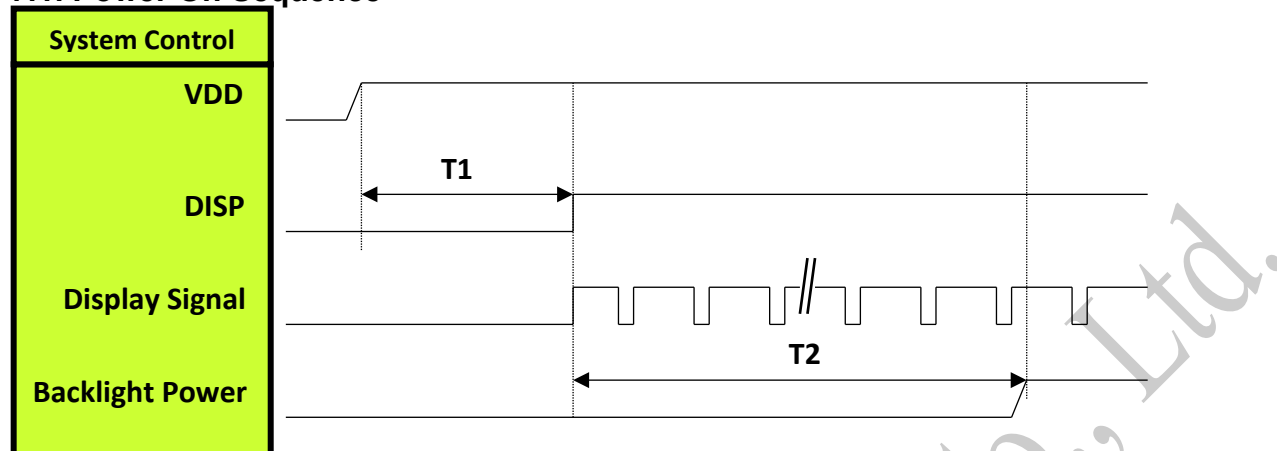
6.3. System Bus Timing for RGB Interface



Item	Symbol	Min.	Typ.	Max.	Unit	Conditions
CLK Pulse Duty	Tclk	40	50	60	%	
VSYNC Setup Time	Tvst	10	-	-	ns	
VSYNC Hold Time	Tvhd	10	-	-	ns	
HSYNC Setup Time	Thst	10	-	-	ns	
HSYNC Hold Time	Thhd	10	-	-	ns	
Data Setup Time	Tdsu	10	-	-	ns	
Data Hold Time	Tdhd	10	-	-	ns	
DE Setup Time	Tdest	10	-	-	ns	
DE Hold Time	Tdehd	10	-	-	ns	

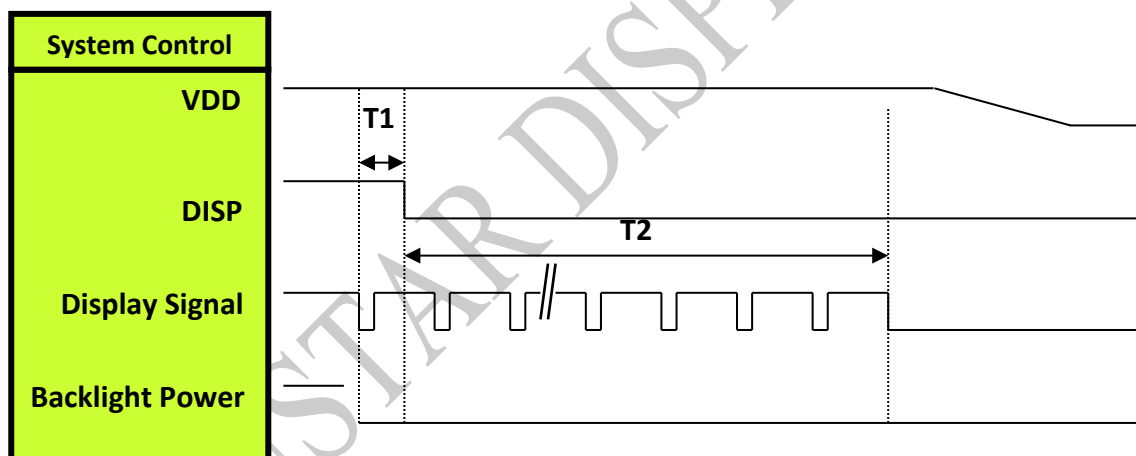
7.Power ON/OFF Sequence

7.1. Power On Sequence



Symbol	Description	Min. Time	Unit
T1	System power stability to DISP="High"	10	ms
T2	Display signal output to Backlight power on	250	ms

7.2. Power Off Sequence



Symbol	Description	Min. Time	Unit
T1	Backlight Power off to DISP ="Low"	5	ms
T2	DISP ="Low" to IC internal voltage discharge complete	100	ms

8. Optical Characteristics

Item		Symbol	Condition.	Min	Typ.	Max.	Unit	Remark
Response time		Tr+Tf	$\theta=0^{\circ}$ 、 $\Phi=0^{\circ}$	-	30	40	.ms	Note 3
Contrast ratio		CR	At optimized viewing angle	800	1000	-	-	Note 4
Color Chromaticity	White	Wx	$\theta=0^{\circ}$ 、 $\Phi=0$	0.27	0.32	0.37		Note 2,6,7
		Wy		0.295	0.345	0.395		
Viewing angle	Hor.	ΘR	$CR\geq 10$	70	80	-	Deg.	Note 1
		ΘL		70	80	-		
	Ver.	ΦT		70	80	-		
		ΦB		70	80	-		
Brightness		-	-	400	500	-	cd/m²	Center of display
Uniformity		(U)	-	75	-	-	%	Note5

Ta=25±2°C

Note 1: Definition of viewing angle range

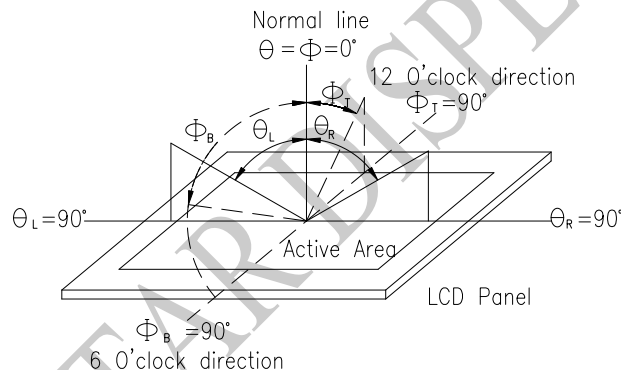


Fig. 8.1. Definition of viewing angle

Note 2: Test equipment setup:

After stabilizing and leaving the panel alone at a driven temperature for 10 minutes, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room. Optical specifications are measured by Topcon BM-7or BM-5 luminance meter 1.0° field of view at a distance of 50cm and normal direction.

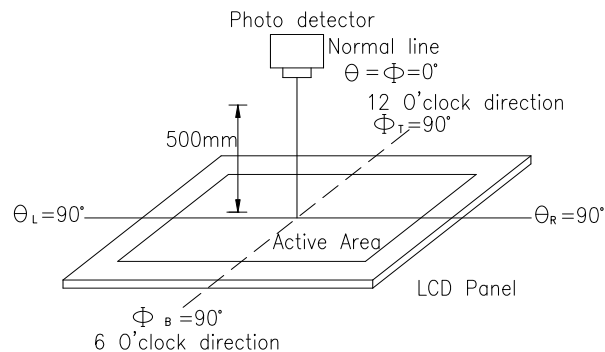
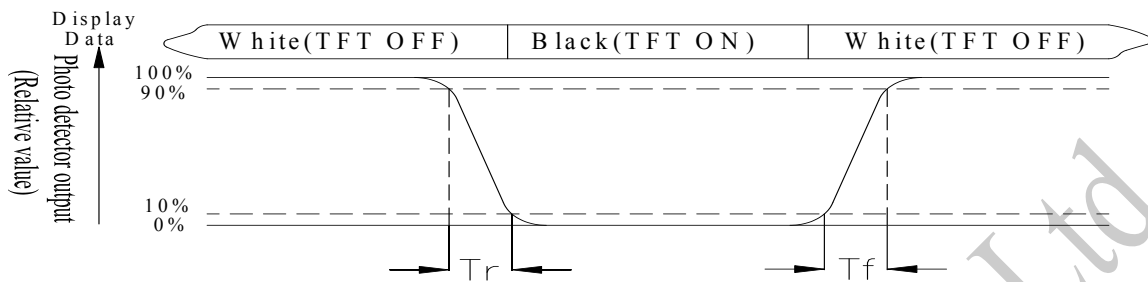


Fig. 8.2. Optical measurement system setup

Note 3: Definition of Response time:

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time, T_r , is the time between photo detector output intensity changed from 90% to 10%. And fall time, T_f , is the time between photo detector output intensity changed from 10% to 90%



Note 4: Definition of contrast ratio:

The contrast ratio is defined as the following expression.

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

Note 5: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (reference the picture in below). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity (U) = $L_{\min}/L_{\max} \times 100\%$

L = Active area length

W = Active area width

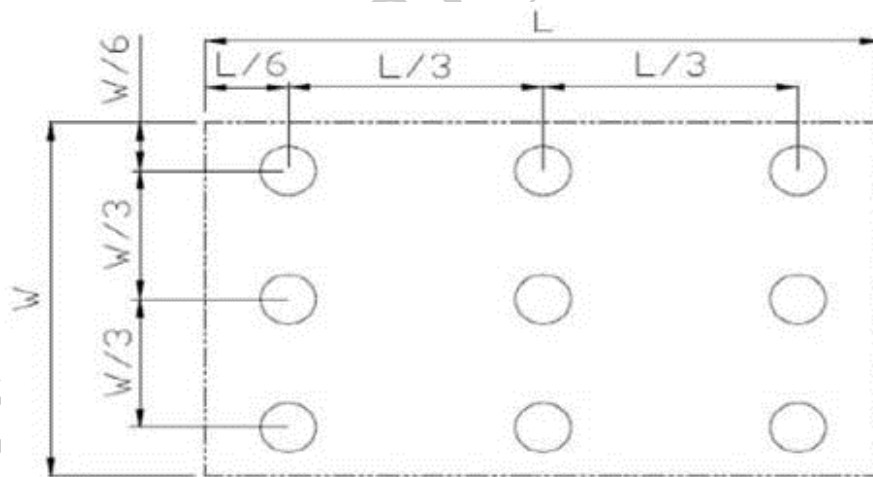


Fig8.3. . Definition of uniformity

Note 6: Definition of color chromaticity (CIE 1931)

Color coordinates measured at the center point of LCD

Note 7: Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.

9.Interface

9.1. LCM PIN Definition

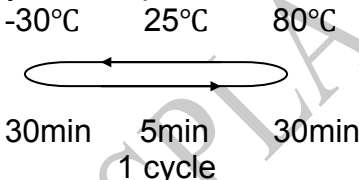
FPC Connector is used for the module electronics interface.

Pin	Symbol	Function	Remark
1	VLED-	Power for LED backlight (Cathode)	
2	VLED+	Power for LED backlight (Anode)	
3	GND	Power Ground	
4	VDD	Power voltage	
5	R0	Red data (LSB)	
6	R1	Red data	
7	R2	Red data	
8	R3	Red data	
9	R4	Red data	
10	R5	Red data	
11	R6	Red data	
12	R7	Red data(MSB)	
13	G0	Green data(LSB)	
14	G1	Green data	
15	G2	Green data	
16	G3	Green data	
17	G4	Green data	
18	G5	Green data	
19	G6	Green data	
20	G7	Green data(MSB)	
21	B0	Blue data(LSB)	
22	B1	Blue data	
23	B2	Blue data	
24	B3	Blue data	
25	B4	Blue data	
26	B5	Blue data	
27	B6	Blue data	
28	B7	Blue data(MSB)	
29	GND	Power Ground	

30	CLK	Sample clock	
31	DISP	Display on/off	
32	NC	No connection	
33	NC	No connection	
34	DE	Data input enable	
35	NC	No connection	
36	GND	Power Ground	
37	NC	No connection	
38	NC	No connection	
39	NC	No connection	
40	NC	No connection	

10. Reliability

Content of Reliability Test (Super Wide temperature, -30°C~80°C)

Environmental Test			
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80°C 200hrs	2
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-30°C 200hrs	1,2
High Temperature/Humidity Operation	The module should be allowed to stand at 60°C,90%RH max	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation  30min 5min 30min 1 cycle	-30°C/80°C 10 cycles	2
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±4KV(contact) ±8KV(air), RS=330Ω CS=150pF 10 times	4

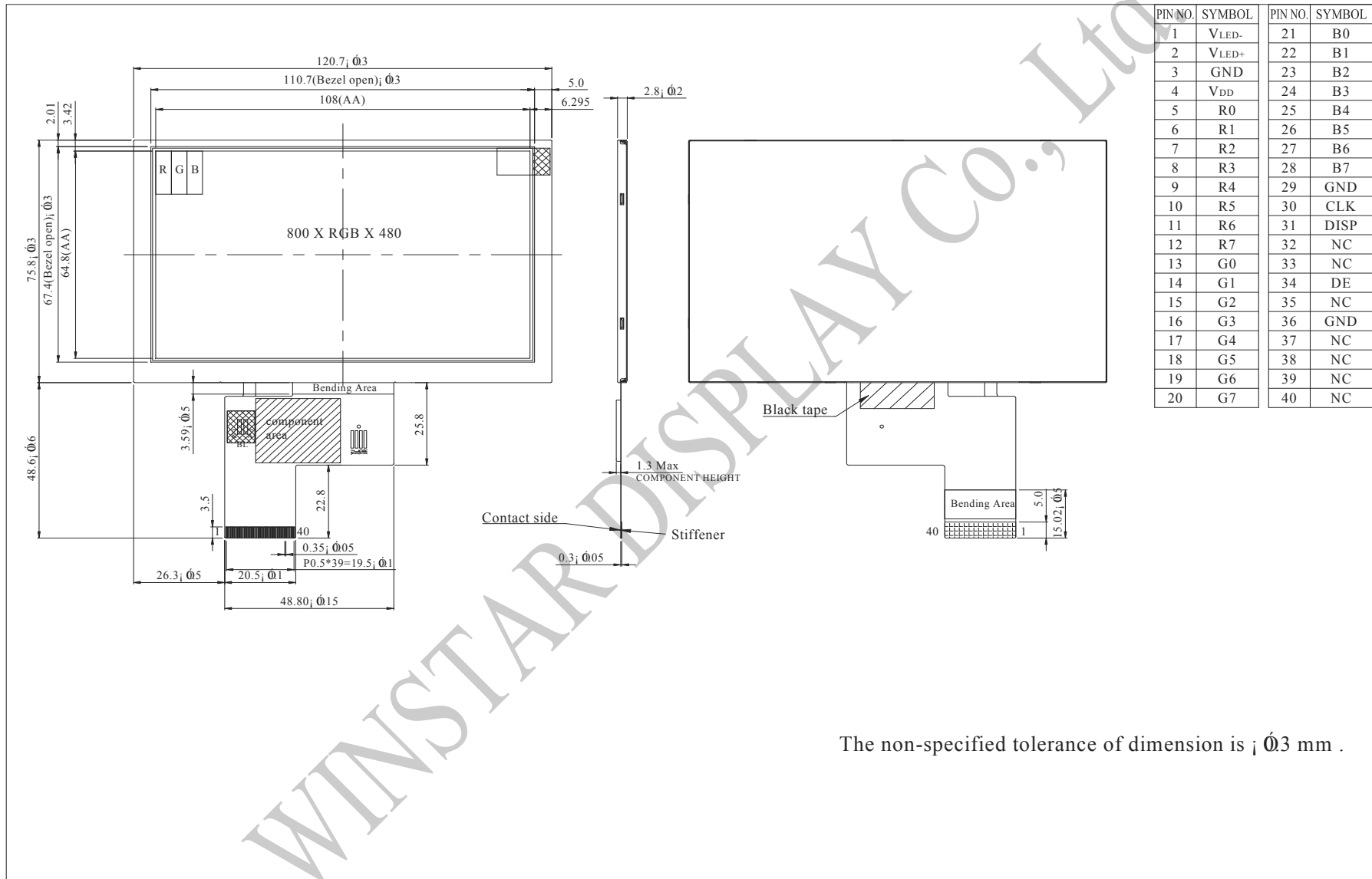
Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

Note4: Endurance test applying the electric stress to the finished product housing

11. Contour Drawing



**1、Panel Specification :**

- | | | |
|----------------------------|-------------------------------|-------------------------------------|
| 1. Panel Type : | ☐ Pass | ☐ NG , _____ |
| 2. View Direction : | ☐ Pass | ☐ NG , _____ |
| 3. Numbers of Dots : | ☐ Pass | ☐ NG , _____ |
| 4. View Area : | ☐ Pass | ☐ NG , _____ |
| 5. Active Area : | ☐ Pass | ☐ NG , _____ |
| 6. Operating Temperature : | ☐ Pass | ☐ NG , _____ |
| 7. Storage Temperature : | ☐ Pass | ☐ NG , _____ |
| 8. Others : | _____ | |

2、Mechanical

- | | | |
|-----------------------------|-------------------------------|-------------------------------------|
| 1. PCB Size : | ☐ Pass | ☐ NG , _____ |
| 2. Frame Size : | ☐ Pass | ☐ NG , _____ |
| 3. Material of Frame : | ☐ Pass | ☐ NG , _____ |
| 4. Connector Position : | ☐ Pass | ☐ NG , _____ |
| 5. Fix Hole Position : | ☐ Pass | ☐ NG , _____ |
| 6. Backlight Position : | ☐ Pass | ☐ NG , _____ |
| 7. Thickness of PCB : | ☐ Pass | ☐ NG , _____ |
| 8. Height of Frame to PCB : | ☐ Pass | ☐ NG , _____ |
| 9. Height of Module : | ☐ Pass | ☐ NG , _____ |
| 10. Others : | ☐ Pass | ☐ NG , _____ |

3、Relative Hole Size :

- | | | |
|-----------------------------|-------------------------------|-------------------------------------|
| 1. Pitch of Connector : | ☐ Pass | ☐ NG , _____ |
| 2. Hole size of Connector : | ☐ Pass | ☐ NG , _____ |
| 3. Mounting Hole size : | ☐ Pass | ☐ NG , _____ |
| 4. Mounting Hole Type : | ☐ Pass | ☐ NG , _____ |
| 5. Others : | ☐ Pass | ☐ NG , _____ |

4、Backlight Specification :

- | | | |
|--|-------------------------------|-------------------------------------|
| 1. B/L Type : | ☐ Pass | ☐ NG , _____ |
| 2. B/L Color : | ☐ Pass | ☐ NG , _____ |
| 3. B/L Driving Voltage (Reference for LED Temp.) : | ☐ Pass | ☐ NG , _____ |
| 4. B/L Driving Current : | ☐ Pass | ☐ NG , _____ |
| 5. Brightness of B/L : | ☐ Pass | ☐ NG , _____ |
| 6. B/L Solder Method : | ☐ Pass | ☐ NG , _____ |
| 7. Others : | ☐ Pass | ☐ NG , _____ |

>> Go to page 2 <<



Winstar Module Number : _____

Page: 2

5、Electronic Characteristics of Module :

- | | | |
|------------------------------|-------------------------------|-------------------------------------|
| 1. Input Voltage : | ☐ Pass | ☐ NG , _____ |
| 2. Supply Current : | ☐ Pass | ☐ NG , _____ |
| 3. Driving Voltage for LCD : | ☐ Pass | ☐ NG , _____ |
| 4. Contrast for LCD : | ☐ Pass | ☐ NG , _____ |
| 5. B/L Driving Method : | ☐ Pass | ☐ NG , _____ |
| 6. Negative Voltage Output : | ☐ Pass | ☐ NG , _____ |
| 7. Interface Function : | ☐ Pass | ☐ NG , _____ |
| 8. LCD Uniformity : | ☐ Pass | ☐ NG , _____ |
| 9. ESD test : | ☐ Pass | ☐ NG , _____ |
| 10. Others : | ☐ Pass | ☐ NG , _____ |

6、Summary :

Sales signature : _____

Customer Signature : _____

Date : / /